March 2008



STEALTHTM II Rectifier

FFPF60SB60DS

Features

- High Speed Switching, t_r < 25ns @ I_F = 4A
- High Reverse Voltage and High Reliability
- RoHS compliant

Applications

- General Purpose
- Switching Mode Power Supply
- Boost Diode in continuous mode power factor corrections
- · Power switching circuits

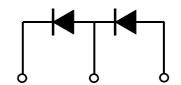
4A, 600V STEALTH™ II Rectifier

The FFPF60SB60DS is STEALTH™ II rectifier with soft recovery characteristics. It is silicon nitride passivated ion-implanted epitaxial planar construction.

This device is intended for use as freewheeling of boost diode in switching power supplies and other power switching applications. Their low stored charge and hyperfast soft recovery minimize ringing and electrical noise in many power switching circuits reducing power loss in the switching transistors.







1. Cathode 2. Anode(Cathode) 3. Anode

Absolute Maximum Ratings T_C = 25°C unless otherwise noted

| Symbol | Parameter | Ratings | Units | |
|-----------------------------------|---|-------------|-------|--|
| V_{RRM} | Peak Repetitive Reverse Voltage | 600 | V | |
| V _{RWM} | Working Peak Reverse Voltage | 600 | V | |
| V _R | DC Blocking Voltage | 600 | V | |
| I _{F(AV)} | Average Rectified Forward Current @ T _C = 100°C | 4 | А | |
| I _{FSM} | Non-repetitive Peak Surge Current 60Hz Single Half-Sine Wave | 40 | А | |
| T _J , T _{STG} | Operating and Storage Temperature Range | -65 to +150 | οС | |

Thermal Characteristics

| Symbol | Parameter | Ratings | Units |
|-----------------|--|---------|-------|
| $R_{\theta JC}$ | Maximum Thermal Resistance, Junction to Case | 8.7 | °C/W |

Package Marking and Ordering Information

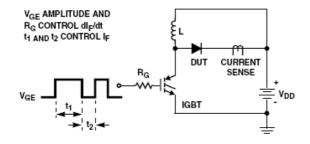
| Device Marking | Device | Package | Reel Size | Tape Width | Quantity |
|----------------|----------------|---------|-----------|------------|----------|
| FFPF60SB60DS | FFPF60SB60DSTU | TO220F | - | - | 50 |

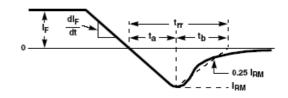
Electrical Characteristics $T_C = 25^{\circ}C$ unless otherwise noted

| Symbol | Parameter | | Min. | Тур. | Max. | Units |
|-------------------|--|----------------------------------|------|------|------|-------|
| V _{FM} 1 | I _F = 4A | $T_{\rm C} = 25^{\rm o}{\rm C}$ | - | 2.2 | 2.6 | V |
| · FIVI · | $I_F = 4A$ | $T_{\rm C} = 125^{\rm o}{\rm C}$ | - | 1.7 | - | • |
| I 1 | $V_{R} = 600V$ | $T_{\rm C} = 25^{\rm o}{\rm C}$ | - | - | 100 | μА |
| I _{RM} 1 | $V_{R} = 600V$ | $T_{\rm C} = 125^{\rm o}{\rm C}$ | - | - | 500 | |
| t _{rr} | $I_F = 1A$, di/dt = 100A/ μ s, $V_R = 30V$ | $T_C = 25^{\circ}C$ | - | 16 | 23 | ns |
| t _{rr} | | | - | 18 | 25 | ns |
| I _{rr} | $I_{\rm F} = 4A$, di/dt = 200A/µs, $V_{\rm R} = 390V$ | $T_C = 25^{\circ}C$ | - | 2 | - | Α |
| S factor | if = 4Λ, di/dt = 200Λ/μs, VR = 390 V | | - | 0.7 | - | |
| Q _{rr} | | | - | 18 | - | nC |
| t _{rr} | | | - | 45 | - | ns |
| I _{rr} | $I_F = 4A$, di/dt = 200A/ μ s, $V_R = 390V$ | $T_{\rm C} = 125^{\rm o}{\rm C}$ | - | 2.8 | - | Α |
| S factor | $I_F = 4A$, $u/ut = 200A/\mu S$, $V_R = 390V$ | 1C = 125 C | - | 1.8 | - | |
| Q _{rr} | | | - | 64 | - | nC |
| W _{AVL} | Avalanche Energy (L = 40mH) | | 5 | - | - | mJ |

Notes:
1: Pulse: Test Pulse width = 300μs, Duty Cycle = 2%

Test Circuit and Waveforms



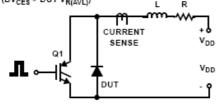


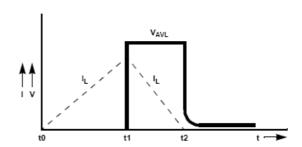
L = 40mH R < 0.1Ω

 $V_{DD} = 50V$

 $\mathsf{EAVL} = 1/2\mathsf{LI2} \; [\mathsf{V}_{\mathsf{R}(\mathsf{AVL})}/(\mathsf{V}_{\mathsf{R}(\mathsf{AVL})} - \mathsf{V}_{\mathsf{DD}})]$

Q1 = IGBT ($BV_{CES} > DUT V_{R(AVL)}$)





Typical Performance Characteristics

Figure 1. Typical Forward Voltage Drop vs. Forward Current

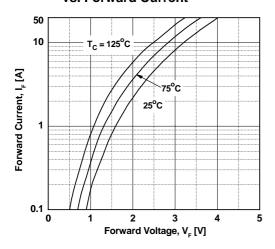


Figure 3. Typical Junction Capacitance

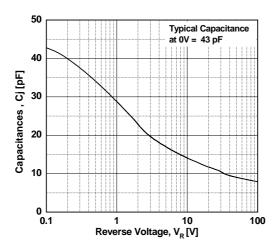


Figure 5. Typical Reverse Recovery Current vs. di/dt

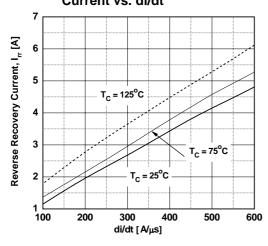


Figure 2. Typical Reverse Current vs. Reverse Voltage

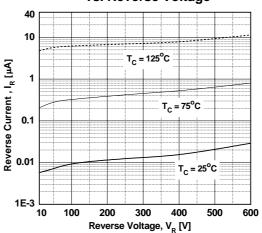


Figure 4. Typical Reverse Recovery Time vs. di/dt

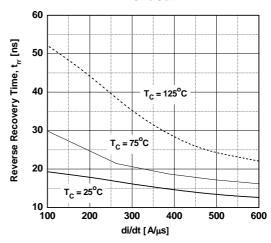
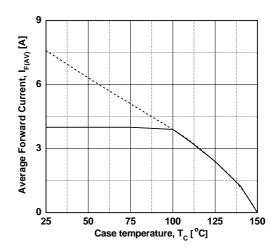
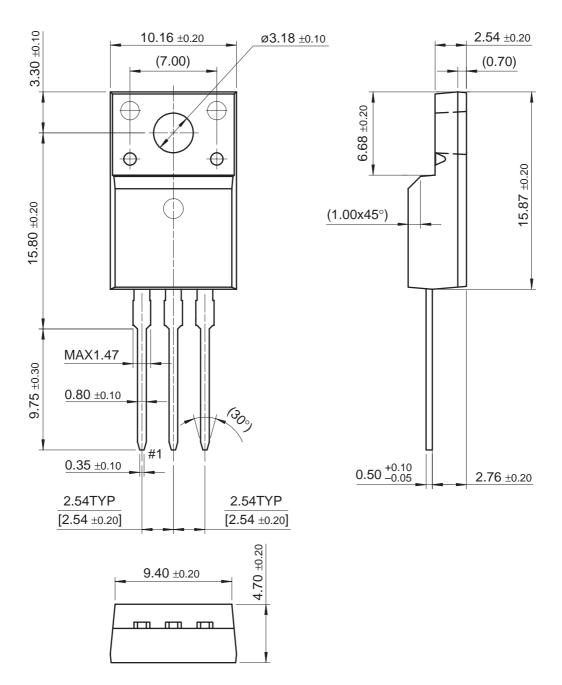


Figure 6. Forward Current Derating Curve



Mechanical Dimensions

TO220F



Dimensions in Millimeters





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